

STM6913A-VB Datasheet **Dual N-Channel 30-V (D-S) MOSFET**

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|--------------------|-----------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) | | |
| 30 | 0.022 at V _{GS} = 10 V | 6.8 | 15 nC | | |
| | 0.026 at V _{GS} = 4.5 V | 6.0 | 10110 | | |

 D_1

 D_2

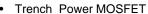
SO-8

Top View

Definition

FEATURES





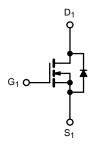
- 100 % UIS Tested
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

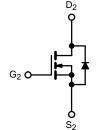


COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Set Top Box
- Low Current DC/DC





N-Channel MOSFET

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATIN | IGS T _A = 25 °C, | unless othe | rwise noted | |
|---|-----------------------------|------------------|----------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V_{DS} | 30 | V | |
| Gate-Source Voltage | | V_{GS} | ± 20 | v |
| | T _C = 25 °C | | 6.8 ^a | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C |] [| 5.6 | |
| Continuous Brain Current (1) = 100 °C) | T _A = 25 °C | l _D | 6.2 ^{b, c} | |
| | T _A = 70 °C |] [| 5.2 ^{b, c} | A |
| Pulsed Drain Current | I _{DM} | 30 | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | lo | 2.25 | |
| Continuous Source-Diam Diode Current | T _A = 25 °C | - I _S | 1.48 ^{b, c} | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 5 | |
| Single Pulse Avalanche Energy | | E _{AS} | 1.25 | mJ |
| | T _C = 25 °C | | 2.7 | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 1.77 | W |
| Maximum Power Dissipation | T _A = 25 °C | 1 'D | 1.78 ^{b, c} | VV |
| | T _A = 70 °C | 1 | 1.14 ^{b, c} | |
| Operating Junction and Storage Temperatur | T_J, T_{sta} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|------|--------|--|
| Parameter | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{a, c, d} | t ≤ 10 s | R _{thJA} | 58 | 70 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 38 | 45 | 5/ / / | |

Notes:

- a. Package limited, T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 110 °C/W.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|---|---|-------|-------|-------|---------|
| Static | | | • | | | • |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 30 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | J 250 WA | | 32 | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | $I_D = 250 \mu A$ | | - 5.0 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$ | 1.0 | | 2.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zara Oata Valla va Daria Oamaal | I _{DSS} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | |
| Zero Gate Voltage Drain Current | | V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | μA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 10 | | | Α |
| | 5 | $V_{GS} = 10 \text{ V, } I_D = 5 \text{ A}$ | 0.022 | | | + |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$ | | 0.026 | | Ω |
| Forward Transconductance ^a | g _{fs} | $V_{DS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ | | 16 | | S |
| Dynamic ^b | <u> </u> | | 1 | | l | l |
| Input Capacitance | C _{iss} | | | 586 | | pF |
| Output Capacitance | C _{oss} | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 117 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 55 | | |
| Total Cata Chausa | Q _g | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ | | 15 | | nC |
| Total Gate Charge | | | | 3.7 | 5.6 | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$ | | 1.4 | | |
| Gate-Drain Charge | Q_{gd} | | | 1.05 | | |
| Gate Resistance | R_g | f = 1 MHz | 0.8 | 4.3 | 8.6 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 24 | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 55 | 100 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 5$ A, V_{GEN} = 4.5 V, R_g = 1 Ω | | 11 | 22 | |
| Fall Time | t _f | | | 8 | 16 | |
| Turn-On Delay Time | t _{d(on)} | | | 4 | 8 | ns - |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 9 | 18 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 5$ A, V_{GEN} = 10 V, R_g = 1 Ω | | 10 | 20 | |
| Fall Time | t _f | | | 6 | 12 | |
| Drain-Source Body Diode Characteristic | s | | | | | _ |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 2.25 | ۸ |
| Pulse Diode Forward Current | I _{SM} | | | | 24 | Α |
| Body Diode Voltage | V_{SD} | I _S = 2 A, V _{GS} = 0 V | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 11 | 20 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | I _F = 5 A, dI/dt = 100 A/μs, T _J = 25 °C | | 4 | 8 | nC |
| Reverse Recovery Fall Time | t_a $I_F = 5 \text{ A, dI/dt} = 100 \text{ A/}$ | | | 7 | | |
| Reverse Recovery Rise Time | t _b | _ | | 4 | | ns |

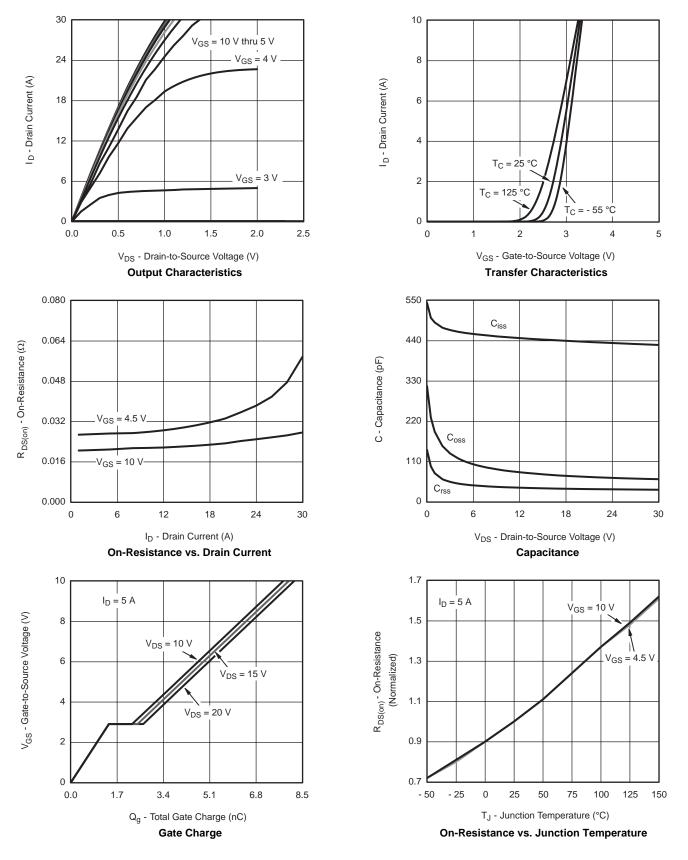
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

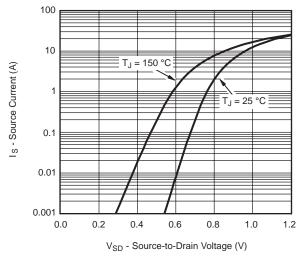
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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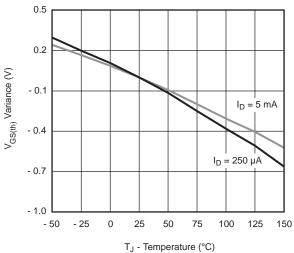




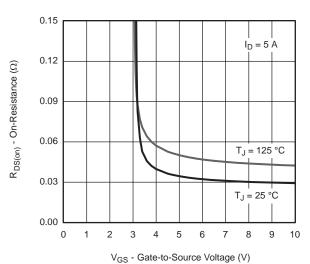




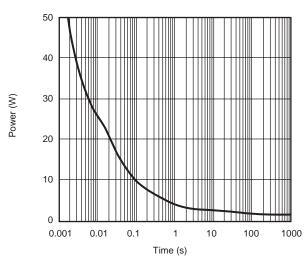
Source-Drain Diode Forward Voltage



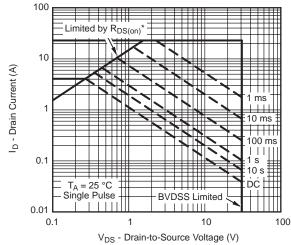
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



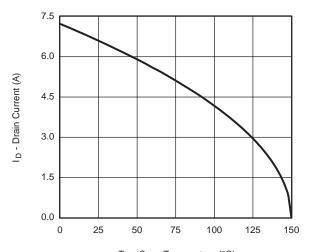
Single Pulse Power



* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

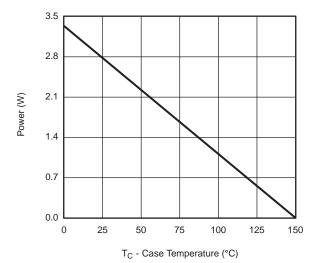
Safe Operating Area, Junction-to-Ambient

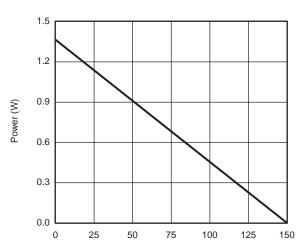




T_C - Case Temperature (°C)

Current Derating*





 T_A - Ambient Temperature (°C)

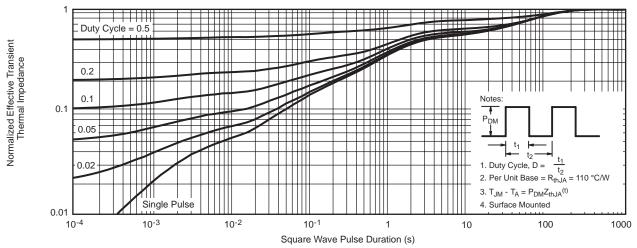
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Power, Junction-to-Foot

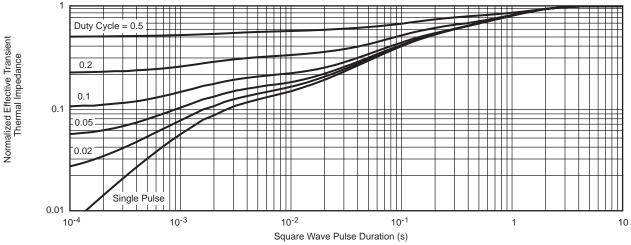
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







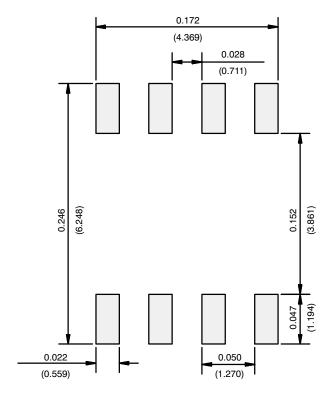
| | MILLIMETERS | | INC | HES | |
|------------------------------|-------------|------|-----------|-------|--|
| DIM | Min | Max | Min | Max | |
| А | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 BSC | | 0.050 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| FCN: C-06527-Rev I 11-Sen-06 | | | | | |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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